



74HC4511; 74HCT4511

BCD to 7-segment latch/decoder/driver

Rev. 4 — 28 March 2024

Product data sheet

1. General description

The 74HC4511; 74HCT4511 is a BCD to 7-segment latch/decoder/driver with four address inputs (A, B, C, D), a latch enable input (\overline{LE}), a ripple blanking input (\overline{BI}), a lamp test input (\overline{LT}), and seven segment outputs (a to g). When \overline{LE} is LOW, the state of the segment outputs (a to g) is determined by the data on A to D. When \overline{LE} goes HIGH, the last data present on A to D are stored in the latches and the segment outputs remain stable. When \overline{LT} is LOW, all the segment outputs are HIGH independent of all other input conditions. With \overline{LT} HIGH, a LOW on \overline{BI} forces all segment outputs LOW. The inputs \overline{LT} and \overline{BI} do not affect the latch circuit. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

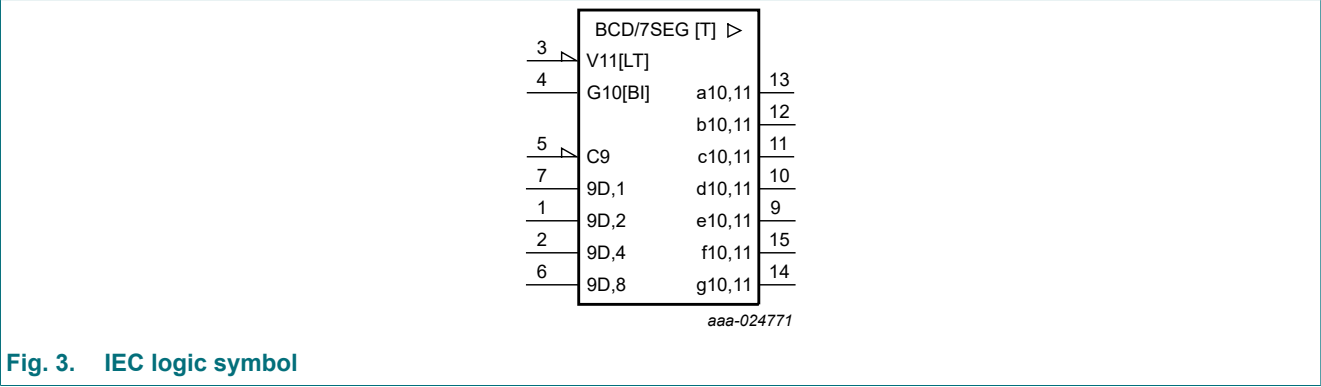
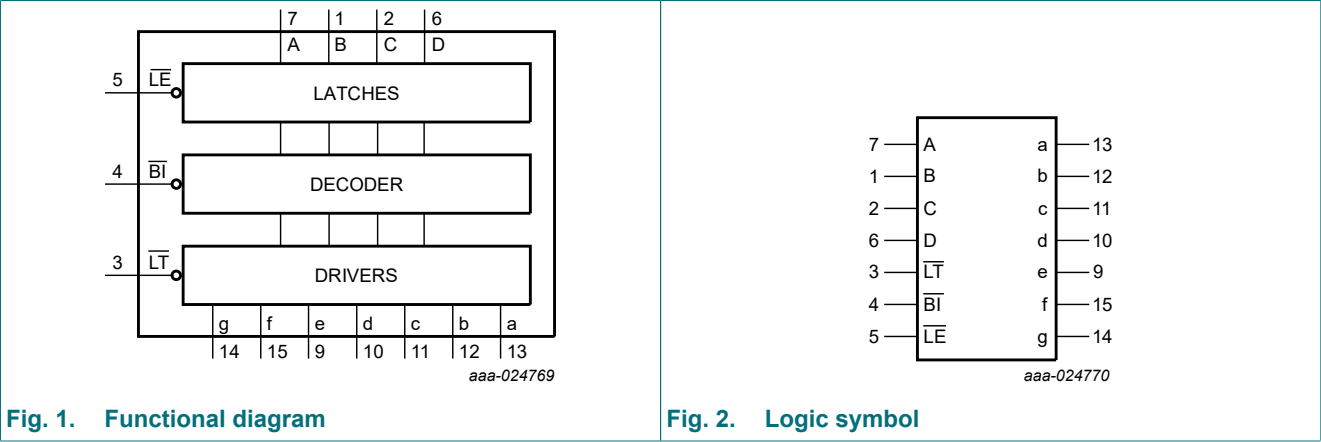
- Complies with JEDEC standard no. 7A
- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Input levels:
 - For 74HC4511: CMOS level
 - For 74HCT4511: TTL level
- Latch storage of BCD inputs
- Blanking input
- Lamp test input
- Driving common cathode LED displays
- Guaranteed 10 mA drive capability per output
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC4511D 74HCT4511D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1

4. Functional diagram



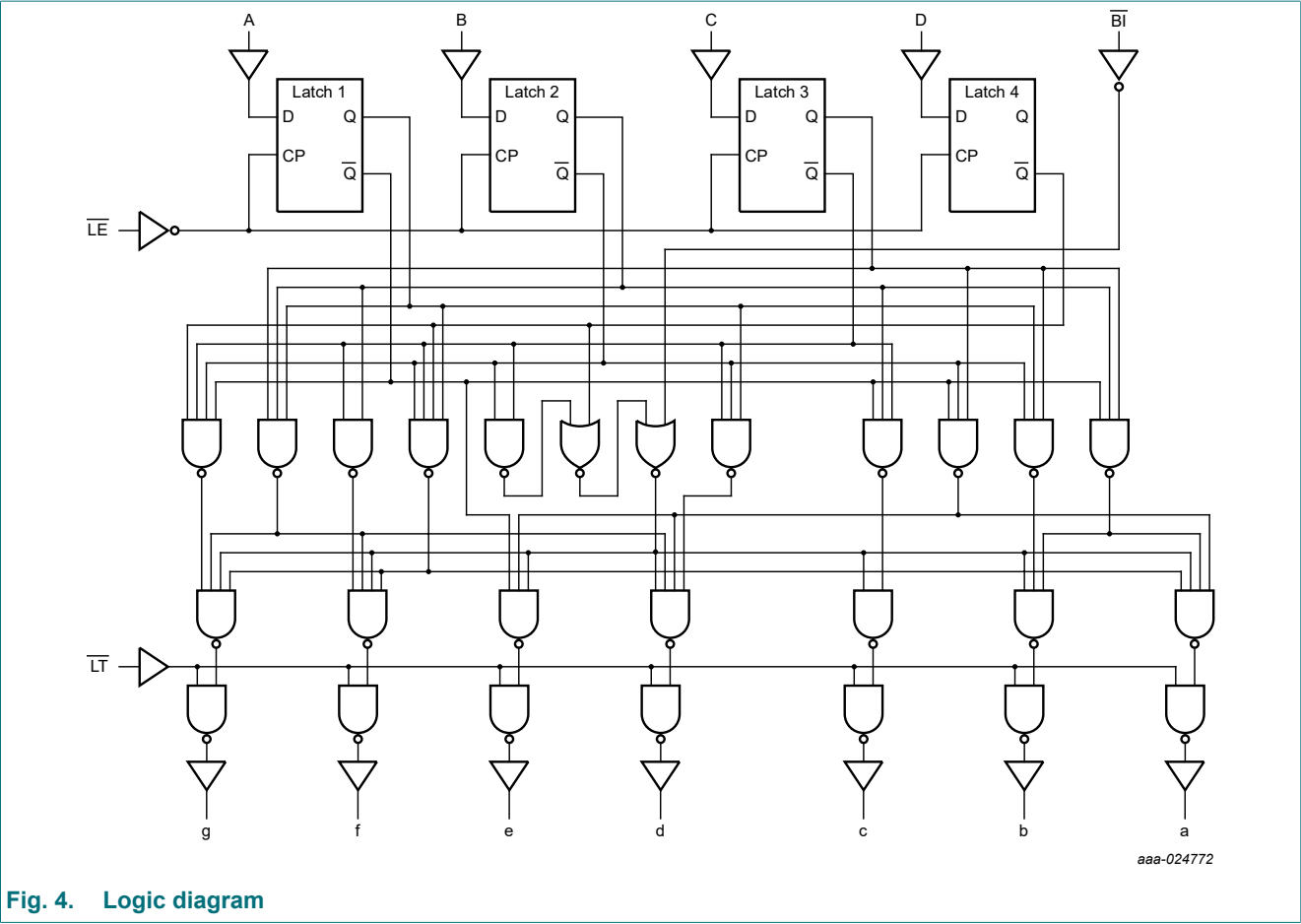
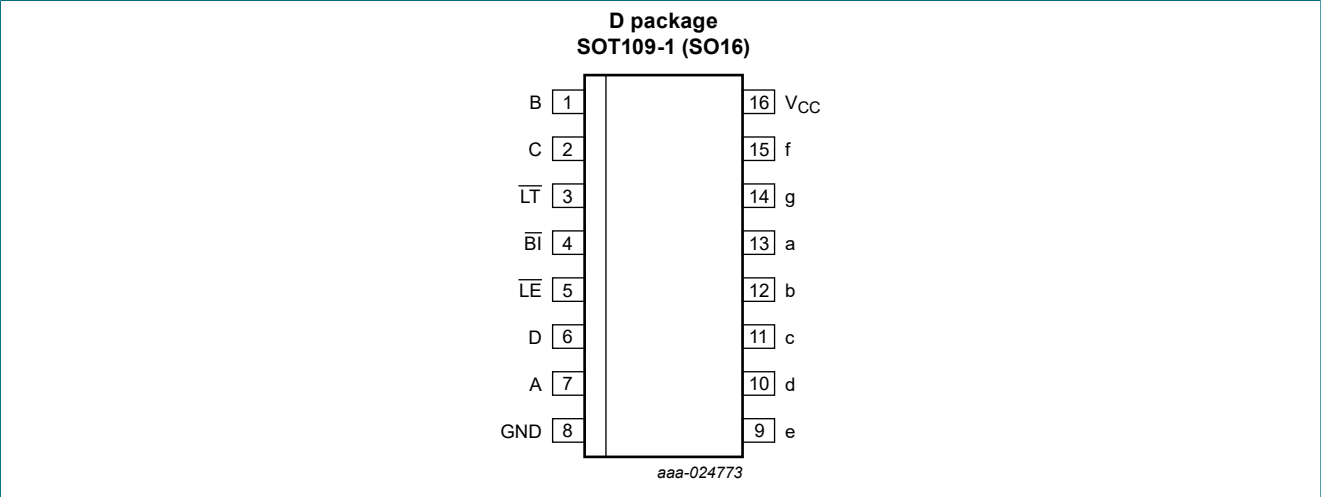


Fig. 4. Logic diagram

5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

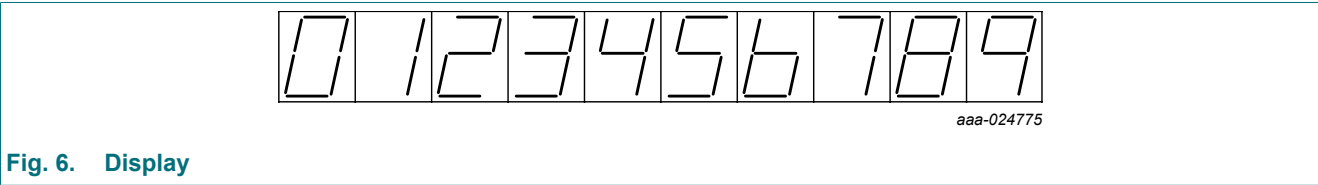
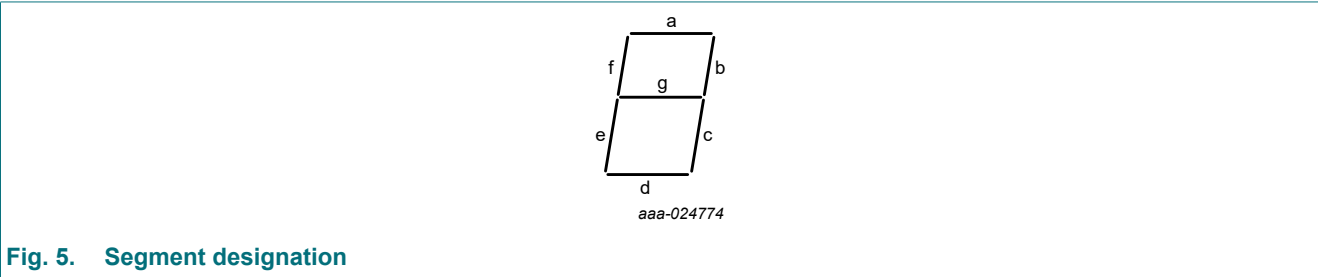
Symbol	Pin	Description
LT	3	lamp test input (active LOW)
BI	4	ripple blanking input (active low)
LE	5	latch enable input (active low)
A, B, C, D	7, 1, 2, 6	BCD address inputs
GND	8	ground (0 V)
a, b, c, d, e, f, g	13, 12, 11, 10, 9, 15, 14	segments outputs
VCC	16	supply voltage

6. Functional description

Table 3. Function table
H = HIGH voltage level; L = LOW voltage level; X = don't care.

Inputs							Outputs							Display
LE	B $\overline{\text{I}}$	LT	D	C	B	A	a	b	c	d	e	f	g	
X	X	L	X	X	X	X	H	H	H	H	H	H	H	8
X	L	H	X	X	X	X	L	L	L	L	L	L	L	blank
L	H	H	L	L	L	L	H	H	H	H	H	H	L	0
L	H	H	L	L	L	H	L	H	H	L	L	L	L	1
L	H	H	L	L	H	L	H	H	L	H	H	L	H	2
L	H	H	L	L	H	H	H	H	H	H	L	L	H	3
L	H	H	L	H	L	L	L	H	H	L	L	H	H	4
L	H	H	L	H	L	H	H	L	H	H	L	H	H	5
L	H	H	L	H	H	L	L	L	H	H	H	H	H	6
L	H	H	L	H	H	H	H	H	H	L	L	L	L	7
L	H	H	H	L	L	L	H	H	H	H	H	H	H	8
L	H	H	H	L	L	H	H	H	H	L	L	H	H	9
L	H	H	H	L	H	L	L	L	L	L	L	L	L	blank
L	H	H	H	L	H	H	L	L	L	L	L	L	L	blank
L	H	H	H	H	L	L	L	L	L	L	L	L	L	blank
L	H	H	H	H	L	H	L	L	L	L	L	L	L	blank
L	H	H	H	H	H	L	L	L	L	L	L	L	L	blank
L	H	H	H	H	H	H	L	L	L	L	L	L	L	blank
H	H	H	X	X	X	X	[1]							[1]

[1] Depends upon the BCD-code applied during the LOW-to-HIGH transition of LE.



7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
I _{IK}	input clamping current	V _I < -0.5 V or V _I > V _{CC} + 0.5 V	-	±20	mA
I _{OK}	output clamping current	V _O < -0.5 V or V _O > V _{CC} + 0.5 V	-	±20	mA
I _O	output current	-0.5 V < V _O < V _{CC} + 0.5 V	-	±25	mA
I _{CC}	supply current		-	+50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	SO16 package [1]	-	500	mW

[1] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC4511			74HCT4511			Unit
			Min	Typ	Max	Min	Typ	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
V _I	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
V _O	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74HC4511										
V _{IH}	HIGH-level input voltage	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
		V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
		V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}								
		I _O = -7.5 mA; V _{CC} = 4.5 V	3.98	-	-	3.84	-	3.7	-	V
		I _O = -10 mA; V _{CC} = 4.5 V	3.6	-	-	3.35	-	3.1	-	V
		I _O = -7.5 mA; V _{CC} = 6.0 V	5.6	-	-	5.45	-	5.35	-	V
		I _O = -10 mA; V _{CC} = 6.0 V	5.48	-	-	5.34	-	5.2	-	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}								
		I _O = 20 µA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 µA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 µA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I _I	input leakage current	V _I = V _{CC} or GND; V _{CC} = 6.0 V	-	-	±0.1	-	±1.0	-	±1.0	µA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 6.0 V	-	-	8.0	-	80	-	160	µA
C _I	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT4511										
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V								
		I _O = -7.5 mA	3.98	-	-	3.84	-	3.7	-	V
		I _O = -10 mA	3.6	-	-	3.35	-	3.1	-	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V								
		I _O = 20 µA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I _I	input leakage current	V _I = V _{CC} or GND; V _{CC} = 5.5 V	-	-	±0.1	-	±1.0	-	±1.0	µA
I _{CC}	supply current	V _I = V _{CC} or GND; V _{CC} = 5.5 V; I _O = 0 A	-	-	8.0	-	80	-	160	µA
ΔI _{CC}	additional supply current	per input pin; V _{CC} = 4.5 V to 5.5 V; V _I = V _{CC} - 2.1 V; I _O = 0 A; other inputs at V _{CC} or GND								
		LT, LE inputs	-	150	540	-	675	-	735	µA
		BI, A, B, C, D inputs	-	30	108	-	135	-	147	µA
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); $C_L = 50$ pF unless otherwise specified; for test circuit see Fig. 11.

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74HC4511										
t _{pd}	propagation delay	A-D to a-g; see Fig. 7 [1]								
		V _{CC} = 2.0 V	-	77	300	-	375	-	450	ns
		V _{CC} = 4.5 V	-	28	60	-	75	-	90	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	24	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	22	51	-	64	-	77	ns
		LE to a-g; see Fig. 8								
		V _{CC} = 2.0 V	-	74	270	-	330	-	405	ns
		V _{CC} = 4.5 V	-	27	54	-	68	-	81	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	23	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	22	46	-	58	-	69	ns
		BI to a-g; see Fig. 9								
		V _{CC} = 2.0 V	-	61	220	-	275	-	330	ns
		V _{CC} = 4.5 V	-	22	44	-	55	-	66	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	19	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	18	37	-	47	-	56	ns
		LT to a-g; see Fig. 7								
		V _{CC} = 2.0 V	-	41	150	-	190	-	225	ns
		V _{CC} = 4.5 V	-	15	30	-	38	-	45	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	12	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	12	26	-	33	-	38	ns
t _t	transition time	see Fig. 7 , Fig. 8 and Fig. 9 [2]								
		V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
t _W	pulse width	LE LOW; see Fig. 8								
		V _{CC} = 2.0 V	80	11	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	4	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	3	-	17	-	20	-	ns
t _{su}	set-up time	A-D to LE; see Fig. 10								
		V _{CC} = 2.0 V	60	14	-	75	-	90	-	ns
		V _{CC} = 4.5 V	12	5	-	15	-	18	-	ns
		V _{CC} = 6.0 V	10	4	-	13	-	15	-	ns
t _h	hold time	A-D to LE; see Fig. 10								
		V _{CC} = 2.0 V	0	-11	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-4	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	-3	-	0		0	-	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
C _{PD}	power dissipation capacitance	V _I = GND to V _{CC} ; V _{CC} = 5 V; f _i = 1 MHz [3]	-	64	-	-	-	-	-	pF
74HCT4511										
t _{pd}	propagation delay	A-D to a-g; see Fig. 7 [1]								
		V _{CC} = 4.5 V	-	28	60	-	75	-	90	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	24	-	-	-	-	-	ns
		LE to a-g; see Fig. 8								
		V _{CC} = 4.5 V	-	27	54	-	68	-	81	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	24	-	-	-	-	-	ns
		B \bar I to a-g; see Fig. 9								
		V _{CC} = 4.5 V	-	23	44	-	55	-	66	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	20	-	-	-	-	-	ns
		LT to a-g; see Fig. 7								
		V _{CC} = 4.5 V	-	16	30	-	38	-	45	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	13	-	-	-	-	-	ns
t _t	transition time	see Fig. 7, Fig. 8 and Fig. 9 [2]								
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
t _W	pulse width	LE LOW; see Fig. 8								
		V _{CC} = 4.5 V	16	5	-	20	-	24	-	ns
t _{su}	set-up time	A-D to LE; see Fig. 10								
		V _{CC} = 4.5 V	12	5	-	15	-	18	-	ns
t _h	hold time	A-D to LE; see Fig. 10								
		V _{CC} = 4.5 V	0	-4	-	0	-	0	-	ns
C _{PD}	power dissipation capacitance	V _I = GND to V _{CC} - 1.5 V; V _{CC} = 5 V; f _i = 1 MHz [3]	-	64	-	-	-	-	-	pF

[1] t_{pd} is the same as t_{PHL} and t_{PLH}.
[2] t_t is the same as t_{THL} and t_{TLH}.
[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW):
P_D = C_{PD} × V_{CC}² × f_i × N + Σ(C_L × V_{CC}² × f_o) where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
Σ(C_L × V_{CC}² × f_o) = sum of outputs.

10.1. Waveforms and test circuit

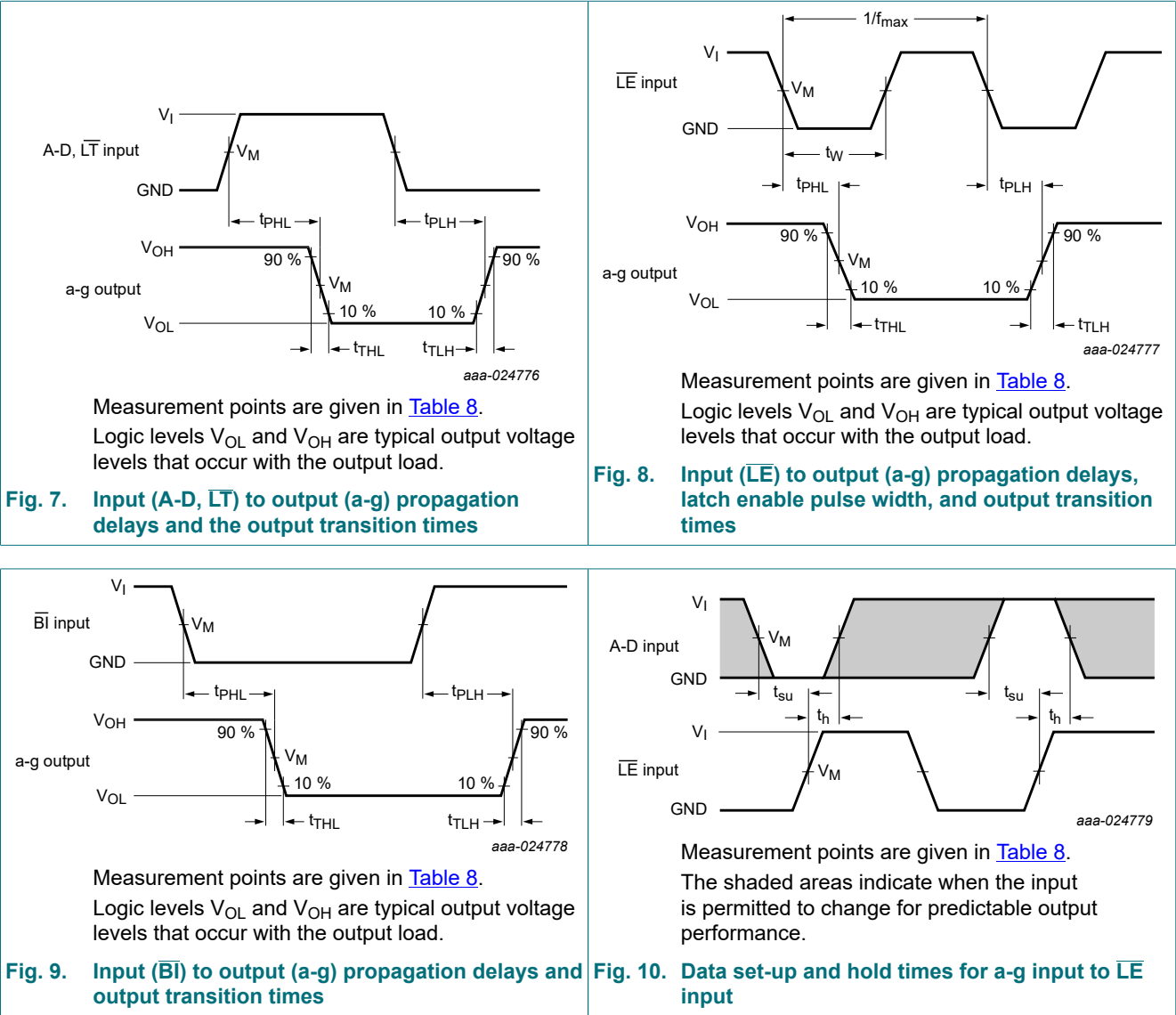
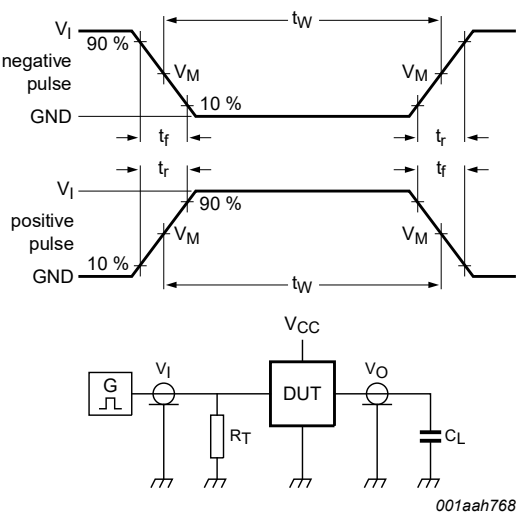


Table 8. Measurement points

Type	Input		Output
	V_M	V_I	V_M
74HC4511	$0.5 \times V_{CC}$	GND to V_{CC}	$0.5 \times V_{CC}$
74HCT4511	1.3 V	GND to 3 V	1.3 V



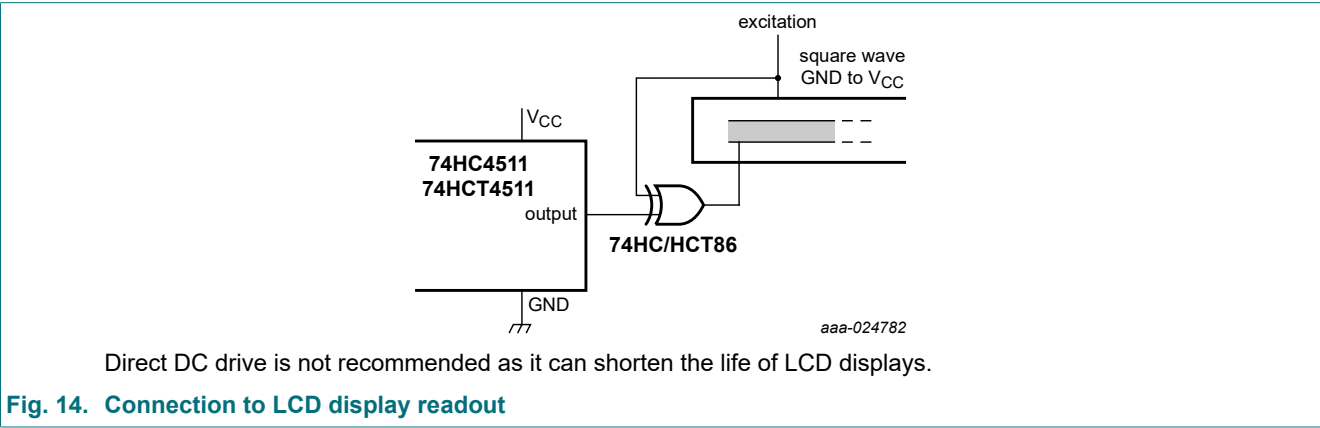
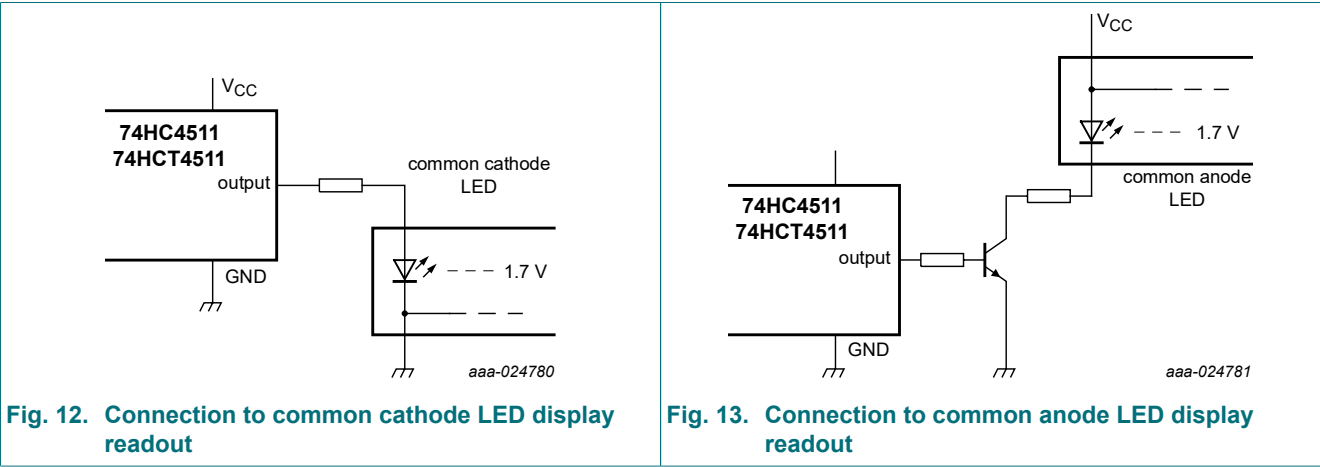
Test data is given in [Table 9](#).
Test circuit definitions:
 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator;
 C_L = Load capacitance including jig and probe capacitance;

Fig. 11. Test circuit for measuring switching times

Table 9. Test data

Type	Input		Load	Test
	V_I	t_r, t_f	C_L	
74HC4511	V_{CC}	6 ns	15 pF, 50 pF	t_{PHL}, t_{PLH}
74HCT4511	3 V	6 ns	15 pF, 50 pF	t_{PHL}, t_{PLH}

11. Application information



12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

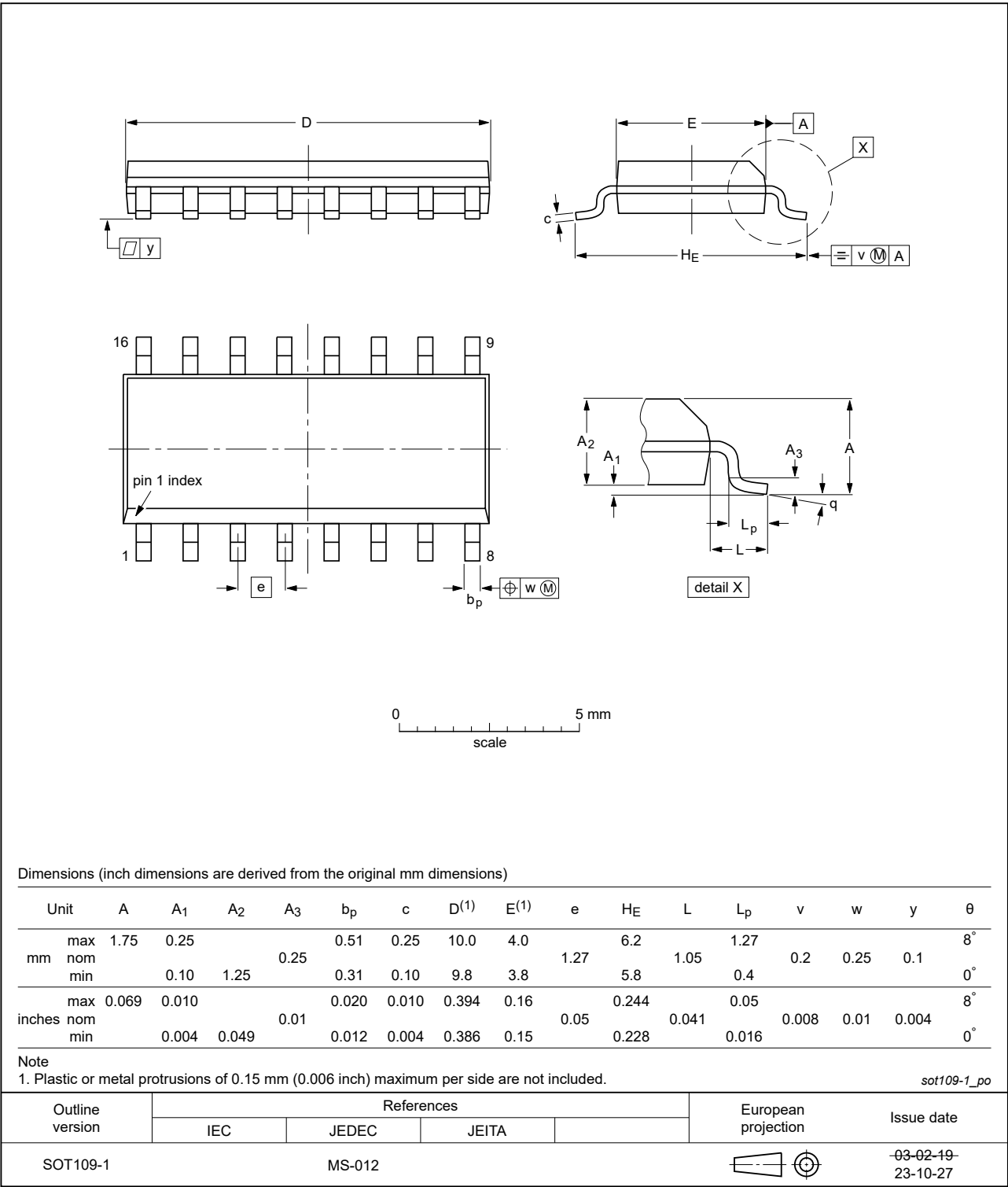


Fig. 15. Package outline SOT109-1 (SO16)

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT4511 v.4	20240328	Product data sheet	-	74HC_HCT4511 v.3
Modifications:	<ul style="list-style-type: none">The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.Legal texts have been adapted to the new company name where appropriate.Section 2: ESD specification updated according to the latest JEDEC standard.Table 4: Derating values for P_{tot} total power dissipation updated.Fig. 11 and Table 9 aligned with specification (errata).Fig. 15: Aligned SO package outline drawing to JEDEC MS-012			
74HC_HCT4511 v.3	20161115	Product data sheet	-	74HC_HCT4511 v.2
Modifications:	<ul style="list-style-type: none">The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.Legal texts have been adapted to the new company name where appropriate.Type numbers 74HC4511N, 74HCT4511N removed.			
74HC_HCT4511 v.2	19901201	Product specification	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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